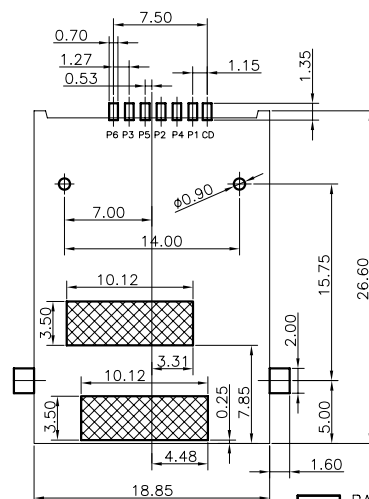
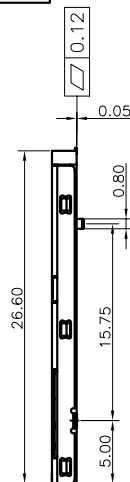
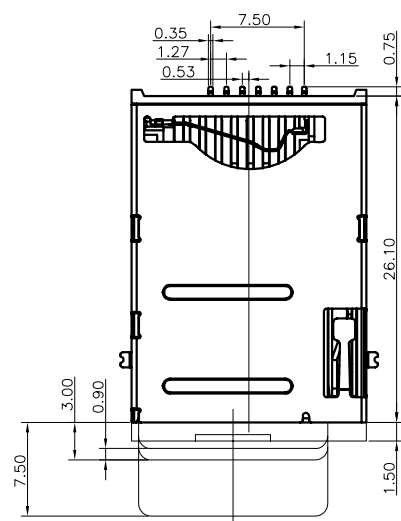
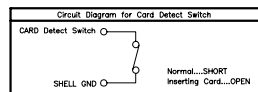
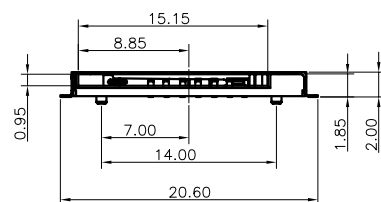


REV	DATE	INSTRUCTION
1.1	2011/09/22	Increase Applicable Card



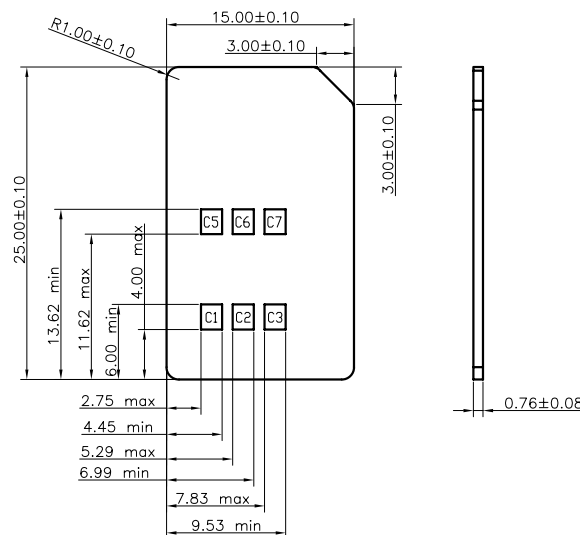
TOP VIEW
PCB LAYOUT RECOMMENDED

PAD AREA
KEEP AREA
KEEP OUT AREA



CONNECTOR PIN NO.	DESCRIPTION	SIM PIN NO.
Pin 1	VCC:PWR Voltage	C 1
Pin 2	RST:Reset signal	C 2
Pin 3	CLK:Clocking signal	C 3
Pin 4	GND:PWR and signal Ground	C 4
Pin 5	VPP:Programming Voltage	C 5
Pin 6	I/O:Serial data input/output	C 6

NO	PART NAME	MATERIAL	STATUS
①	HOUSING	LCP	BLACK
②	TERMINAL	BRONZE T=0.2	GF/T
③	SHELL	COPPER ALLOY T=0.2	TIN



[410106] SERIES

SIM Card Connector,6 Pin,
Height 2.0,Type 1,
Physical:

Housing: High Temperature Thermoplastic

Contact: Copper Alloy

Specifications:

Voltage Current Rating: 1A. 50V AC

Insulation Resistance: 1000Mohm min

Contact Resistance: 100m ohm max

Dielectric Withstanding Voltage:
AC 500V For 1 Minute

Temperature Rating: -40°C To +85°C

IR Reflow Soldering Temperature:

Lead Part: 220°C,5sec

RoHS Part: 260°C,5sec

ORDERING CODE

410106 1 02 01 2 -13 LF
1 2 3 4 5 6 7

1.SERIES NO.

2.MATERIAL

1=LCP/UL 94V-0

3.HEIGHT

02=Height 2.0MM

4.PLATED

01=SELECTIVE GOLD FLASH

5.PACK

2=TAPE IN REEL

6.ECN CODE

7.PRODUCT'S STATUS

LF=RoHS COMPLIANT

ENGINEER DWG	ANYTRONIC	
	CORPORATION LIMITED	
TITLE	SIM CARD	
DWG NO.	410106102XXX-13	
SCALE	1:1	SHEET 1 OF 2

REV.	DATE	APPD.	CHR.	DR.	TOLERANCE UNLESS OTHERWISE SPECIFIED
1.0	2011/09/21	BING	DANIEL	JAMES	LINEAR
1.1	2011/09/22	BING	DANIEL	JAMES	LINEAR
					ANGLES

0.0±0.30
0.00±0.20
±5

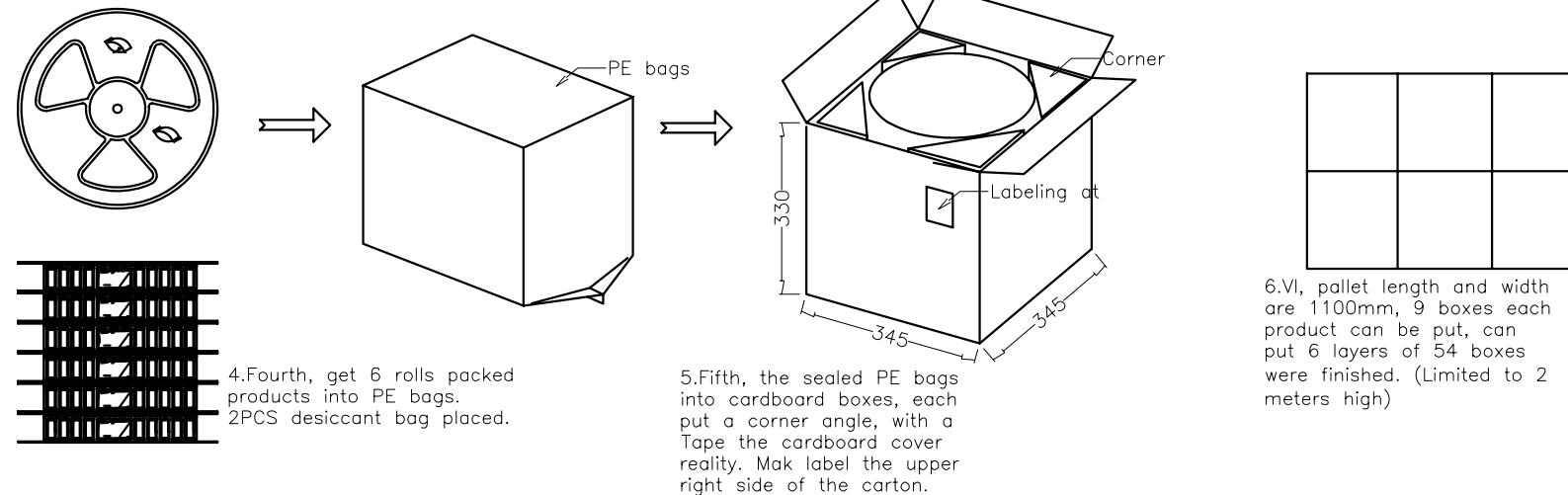
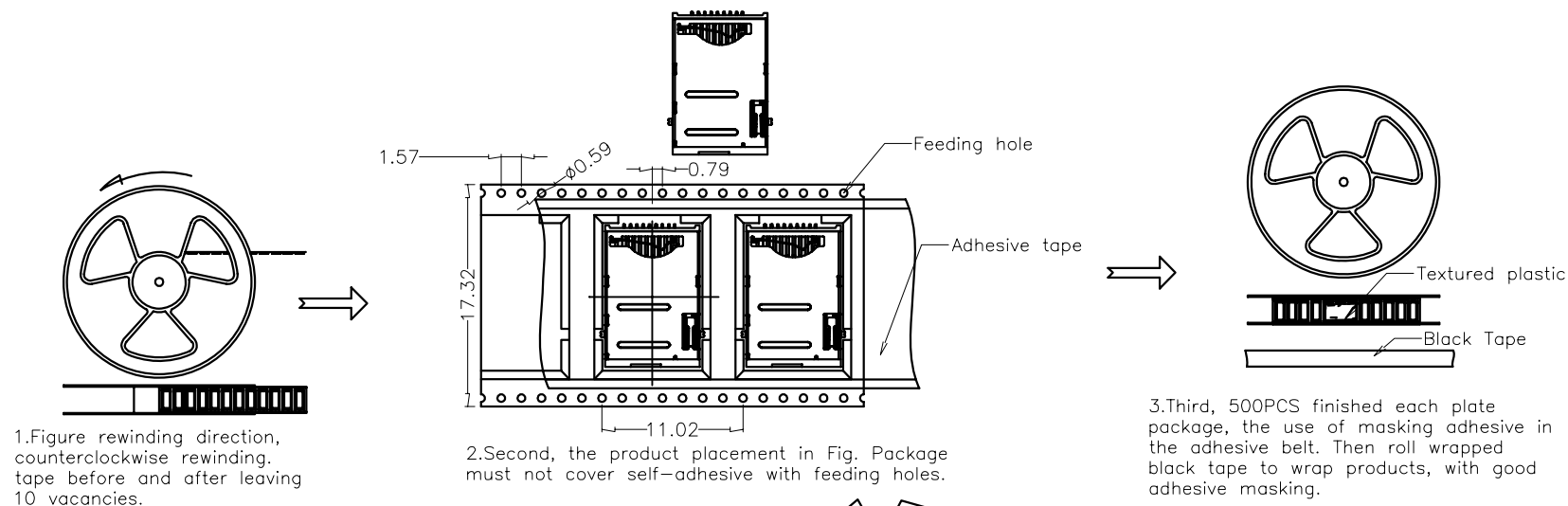


UNIT:mm

SIZE: A4

REV	DATE	INSTRUCTION
1.1	2011/09/22	Increase Applicable Card

[410106] SERIES



ENGINEER DWG	ANYTRONIC CORPORATION LIMITED	
UNIT:mm	TITLE	SIM CARD
SIZE: A4	DWG NO.	410106102XXX-13
	SCALE	1:1 SHEET 2 OF 2

REV.	DATE	APPD.	CHR.	DR.	TOLERANCE UNLESS OTHERWISE SPECIFIED
1.0	2011/09/21	BING	DANIEL	JAMES	LINEAR
1.1	2011/09/22	BING	DANIEL	JAMES	LINEAR
					ANGLES